MA2C840 (MA840)

Silicon epitaxial planar type

For AFC of UHF and VHF electronic tuners

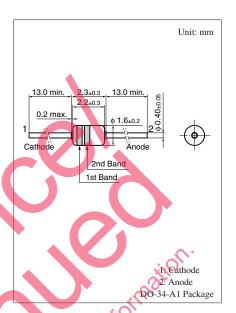
■ Features

- Extra-small DHD envelope, allowing to insert a 5 mm pitch hole
- Small series resistance r_D
- Large variable capacitance range

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	32	V
Maximum peak reverse voltage *	V_{RM}	34	V
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Note) *: $R_L = 2.2 \text{ k}\Omega$, 1 pulse



■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	I _F = 100 mA			1.1	V
Reverse current	I_{R}	$V_R = 30 \text{ V}$			10	nA
Diode capacitance	$C_{D(2V)}$	$V_R = 2 \text{ V, f} = 1 \text{ MHz}$	10.5		16.0	pF
	C _{D(10V)}	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$	3.3		5.7	pF
Capacitance ratio *	$C_{D(2V)}/C_{D(10V)}$	04/100	2.5		3.4	_
Series resistance	r_{D}	$C_D = 9 \text{ pF, } f = 470 \text{ MHz}$			1.2	Ω

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

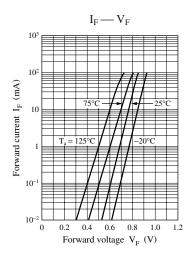
- 2. Absolute frequency of input and output is 470 MHz.
- 3. *: Rank classification

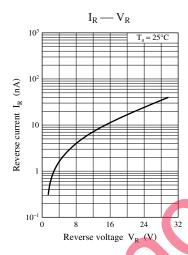
Rank	A ?	В
$C_{D(2V)} / C_{D(10V)}$	2.5 to 3.0	2.8 to 3.4

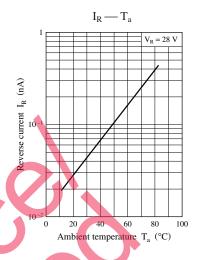
■ Cathode Mark

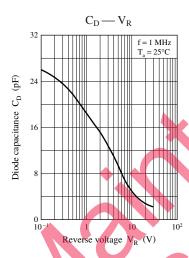
Class	А	В
1st band	Light Blue	Light Blue
2nd band	White	Green

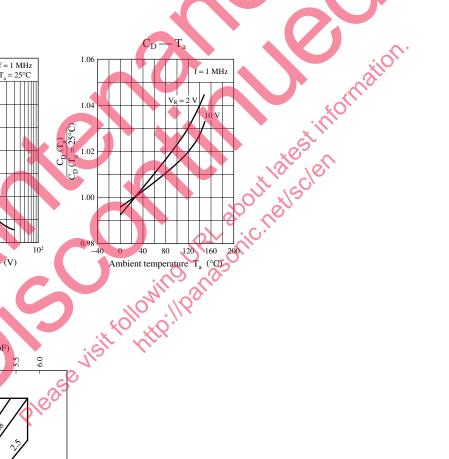
Note) The part number in the parenthesis shows conventional part number.





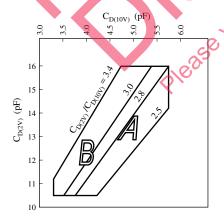






C_D rank classification

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SKD00003CED

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